### **IBIS Update**

IBIS

http://www.ibis.org/

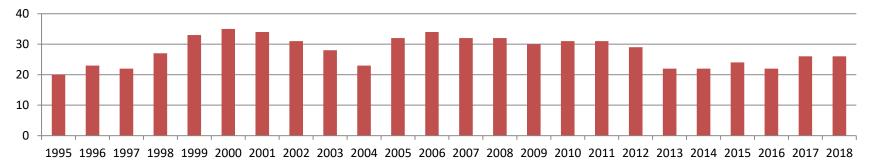
Mike LaBonte SiSoft Chair, IBIS Open Forum

2018 DesignCon IBIS Summit Santa Clara, California February 2, 2018

### 26 IBIS Members



#### Number of Members by Year



## IBIS Officers 2017-2018

Chair: Mike LaBonte, SiSoft

Vice-Chair: Lance Wang, IO Methodology Inc.

Secretary: Randy Wolff, Micron Technology

Treasurer: Bob Ross, Teraspeed Labs

- Librarian: Anders Ekholm, Ericsson
- Postmaster: Curtis Clark, ANSYS

Webmaster: Mike LaBonte, SiSoft



2018 Officer Election nominations open May 17

## **IBIS** Meetings

- Weekly teleconferences
  - Quality Task Group (Tuesdays)



- Advanced Technology Modeling Task Group (Tuesdays)
- Interconnect Task Group (Wednesdays)
- Editorial Task Group (some Fridays)
- IBIS Open Forum teleconference every 3 weeks
  499 meetings so far
- IBIS Summit meetings: DesignCon, IEEE SPI, EDICON USA, EPEPS, Shanghai, Taipei, Tokyo

## SAE ITC

- SAE Industry Technologies Consortia is the parent organization of the IBIS Open Forum
- IBIS is assisted by SAE employees José Godoy, Phyllis Gross, Dorothy Lloyd
- SAE ITC provides financial, legal, and other services
- http://itc.sae.org/



## Task Groups

- Interconnect Task Group
  - Chair: Michael Mirmak
  - <u>http://ibis.org/interconn\_wip/</u>
  - Develop on-die/package/module/connector interconnect modeling BIRDs
- Advanced Technology Modeling Task Group
  - Chair: Arpad Muranyi
  - <u>http://ibis.org/atm\_wip/</u>
  - Develop most other technical BIRDs
- Quality Task Group
  - Chair: Mike LaBonte
  - <u>http://ibis.org/quality\_wip/</u>
  - Oversee IBISCHK parser testing and development
- Editorial Task Group
  - Chair: Michael Mirmak
  - <u>http://ibis.org/editorial\_wip/</u>
  - Produce IBIS Specification documents

BIRD = Buffer Issue Resolution Document

**IBIS** Update

### **IBIS Milestones**

#### I/O Buffer Information Specification

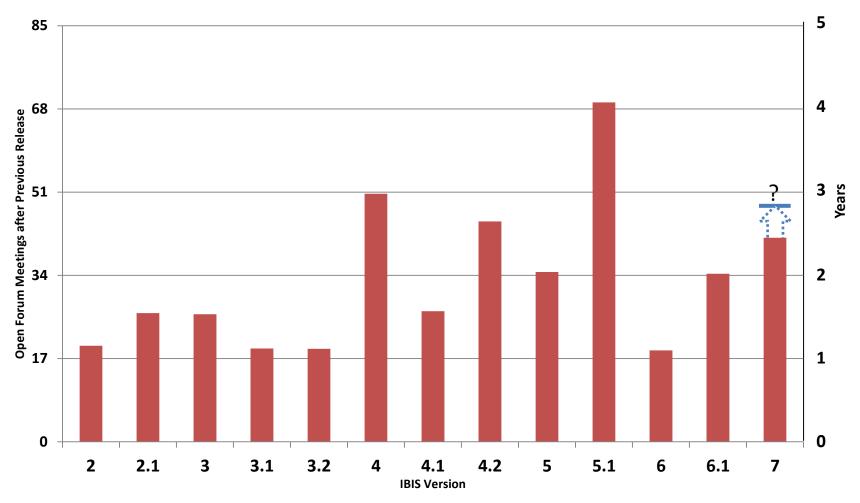
- 1993-1994 IBIS 1.0-2.1:
  - Behavioral buffer model (fast simulation)
  - Component pin map (easy EDA import)
- 1997-1999 IBIS 3.0-3.2:
  - Package models
  - Electrical Board Description (EBD)
  - Dynamic buffers
- 2002-2006 IBIS 4.0-4.2:
  - Receiver models
  - AMS languages
- 2007-2012 IBIS 5.0-5.1:
  - IBIS-AMI SerDes models
  - Power aware
- 2013-2015 IBIS 6.0-6.1:
  - PAM4 multi-level signaling
  - Power delivery package models
- 2018? IBIS 7.0



### Other Work

- 1995: ANSI/EIA-656
  IBIS 2.1
- 1999: **ANSI/EIA-656-A** 
  - IBIS 3.2
- 2001: IEC 62014-1
  - IBIS 3.2
- 2003: ICM 1.0
  - Interconnect Model Specification
- 2006: ANSI/EIA-656-B
  IBIS 4.2
- 2009: **Touchstone 2.0**\*
- 2011: IBIS-ISS 1.0
  - Interconnect SPICE Subcircuit specification

### **IBIS Version Development**



As of 2-Feb-2018

## Possible IBIS 7.0 Timeline

<b>Meeting Date</b>	Milestone
4/21/2017	Vote to establish 7.0 as the next IBIS version passes
5/12/2017	BIRD review and acceptance (10 meetings)
•••	•••
2/16/2018	
3/9/2018	Vote to approve 7.0 BIRD set is scheduled for next meeting
3/30/2018	7.0 BIRD set accepted. Editorial work begins
4/20/2018	
5/11/2018	Editorial announces 7.0 ready. Review period begins
6/1/2018	
6/22/2018	Vote to ratify 7.0 scheduled for next meeting
7/13/2018	7.0 ratified
	New! IBIS 7.0 IBIS

**IBIS** Update

## BIRDs Possibly Included in IBIS 7.0

BIRD	Title
147.6	Back-channel Support
158.7	AMI Ts4file Analog Buffer Models
179	New IBIS-AMI Reserved Parameter Special_Param_Names
180	Require Unique Pin Names in [Pin]
182	POWER and GND [Pin] signal_name as [Pin Mapping] bus_label
183	[Model Data] Matrix Subparameter Terminology Correction
184.2	Model_name and Signal_name Restriction for POWER and GND Pins
185.2	Section 3 Reserved Word Guideline Update
186.4	File Naming Rules
187.3	Format and Usage Out Clarifications
188.1	Expanded Rx Noise Support for AMI
189.4	Interconnect Modeling Using IBIS-ISS and Touchstone
191.2	Clarifying Locations for Si_location and Timing_location
192.1	Clarification of List Default Rules
193	Figure 29 corrections

Green = currently accepted BIRD

### BIRDs Possibly Excluded from IBIS 7.0

BIRD	Title
125.1	Make IBIS-ISS Available for IBIS Package Modeling
145.3	Cascading IBIS I/O buffers with [External Circuit]s using the [Model Call] keyword
166.2	Resolving problems with Redriver Init Flow
163	Instantiating and Connecting [External Circuit] Package Models with [Circuit Call]
164	Allowing Package Models to be defined in [External Circuit]
165	Parameter Passing Improvements for [External Circuit]s
181.1	I-V Table Clarifications
190	Clarification for Redriver Flow

White = currently not an accepted BIRD

# [Thank You]



IBIS Open Forum: Web: <u>http://www.ibis.org</u> Email: <u>ibis-info@freelists.org</u>

We welcome participation by all IBIS model makers, EDA tool vendors, IBIS model users, and interested parties.